

HCM1A0805V3

Automotive grade high current power inductor



Photo is representative

Product features

- AEC-Q200
- High current carrying capacity
- Magnetically shielded, low EMI
- DC-DC converter applications up to 1 MHz
- Filtering applications up to Self resonant frequency (SRF) [See product specification table]
- Inductance range from 0.22 μ H to 100 μ H
- Current range from 1.4 A to 32 A
- 8.4 mm x 8.0 mm and 8.0 mm x 7.5 mm footprint surface mount package in a 5.4 mm height
- Alloy powder core material
- Moisture sensitivity level (MSL): 1

Applications

- Body electronics
 - Central body control module
 - Vehicle access control system
 - Headlamps, tail lamps and interior lighting and LED lighting
 - Heating ventilation and air conditioning controllers (HVAC)
 - Doors, window lift and seat control
- Advanced driver assistance systems
 - Adaptive cruise control (ACC)
 - Automatic parking control
 - Collision avoidance system/ Car black box system
- Infotainment and cluster electronics
 - Audio subsystem: head unit and trunk amp
 - Digital instrument cluster
 - In-vehicle infotainment (IVI) and navigation
 - Port power/USB HUB for front and rear passengers
- Chassis and safety electronics
 - Airbag control unit
 - Electronic stability control system (ESC)
- Engine and powertrain systems
 - Electric pumps, motor control and auxiliaries
 - Powertrain control module (PCU)/ Engine control unit (ECU)
 - Transmission Control Unit (TCU)

Environmental compliance and general specifications

- Storage temperature (component): -55 °C to +155 °C
- Operating temperature range: -55 °C to +155 °C (ambient plus self-temperature rise)



Powering Business Worldwide

Product specifications

Part number ⁶	OCL ¹ (μH) ±20%	FLL ² (μH) minimum	I _{rms1} ³ (A)	I _{rms2} ³ (A)	I _{sat} ⁴ (A)	DCR (mΩ) maximum @ +20 °C	SRF (MHz) typical	K-factor ⁵
HCM1A0805V3-R22-R	0.22	0.14	32	28	50	1.2	165	443
HCM1A0805V3-R47-R	0.47	0.30	21.5	19	26	2.8	105	295
HCM1A0805V3-R68-R	0.68	0.43	19.5	17	22	3.5	80	284
HCM1A0805V3-1R0-R	1.0	0.64	16	14	15	4.8	50	261
HCM1A0805V3-2R2-R	2.2	1.41	11	9.5	9.6	8.5	28	170
HCM1A0805V3-3R3-R	3.3	2.1	10	8.5	7.2	10	21	159
HCM1A0805V3-4R7-R	4.7	3.0	8.0	7.0	8.0	15.6	16.5	118
HCM1A0805V3-100-R	10	6.4	4.3	3.8	6.2	60	12	62
HCM1A0805V3-150-R	15	9.6	4.3	3.8	4.6	52	9.5	65
HCM1A0805V3-220-R	22	14	3.5	3.1	4.0	70	7.5	52
HCM1A0805V3-330-R	33	21	2.8	2.5	4.0	125	6.1	41
HCM1A0805V3-470-R	47	26	2.5	2.2	4.7	147	4.0	52
HCM1A0805V3-680-R	68	38	2.1	1.7	4.3	210	4.0	28
HCM1A0805V3-101-R	100	56	1.8	1.4	3.3	310	2.0	29

1. Open circuit inductance (OCL) test parameters: 100 kHz, 1.0 Vrms, 0.0 Adc, +25 °C

2. Full load inductance (FLL) test parameters: 100 kHz, 1.0 Vrms, Isat., +25 °C

3. Irms1: DC current for an approximate temperature rise of 40 °C without core loss.

Irms2: DC current for an approximate temperature rise of 30 °C without core loss.

Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +155 °C under worst case operating conditions verified in the end application.

4. Isat: Peak current for approximately 20% rolloff @ +25 °C for R22 to 330, 30% rolloff @ +25 °C for 470, 680 and 101.

5. K-factor: Used to determine Bp-p for core loss (see graph). Bp-p = K * L * ΔI. Bp-p: (Gauss), K: (K-factor from table), L: (Inductance in μH), ΔI (Peak to peak ripple current in Amps).

6. Part Number Definition: HCM1A0805V3-xxx-R

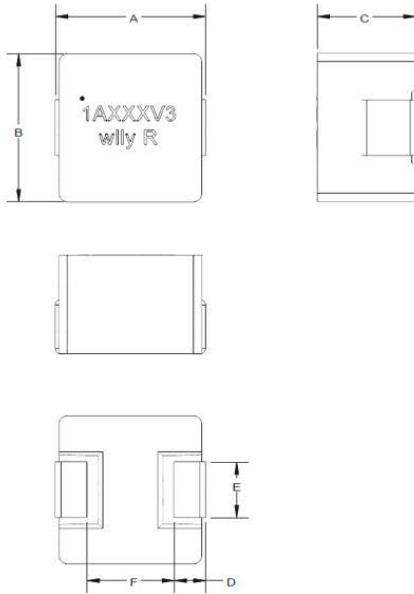
HCM1A0805V3= Product code and size

xxx= Inductance value in μH, R= decimal point, if no R is present last digit indicates number of zeros

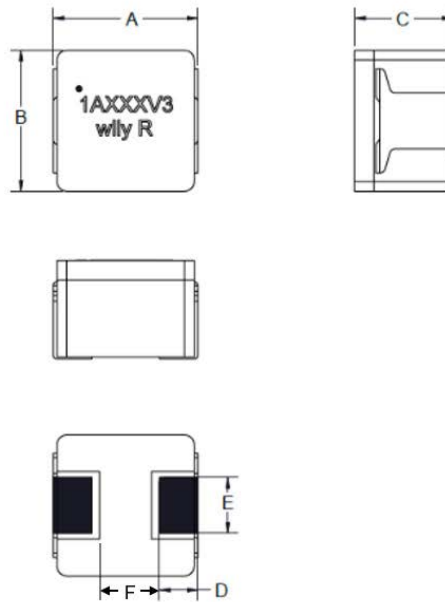
-R = RoHS compliant

Dimensions- (mm)

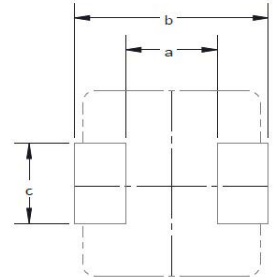
HCM1A0805V3-R22 to 330-R



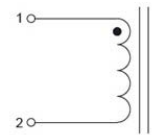
HCM1A0805V3-470 to 101-R



Recommended pad layout



Schematic



Part number	A	B	C	D	E	F	a	b	c
HCM1A0805V3-R22-R	8.1 ±0.3	8.0 max	5.4 max	1.7 ±0.3	2.7 ±0.2	4.7 typ.	4.0 typ.	8.5 typ.	3.2 typ.
HCM1A0805V3-R47 and R68-R	8.1 ±0.3	8.0 max	5.4 max	1.7 ±0.3	1.8 ±0.3	4.7 typ.	4.0 typ.	8.5 typ.	2.4 typ.
HCM1A0805V3-1R0 to 330-R	8.1 ±0.3	8.0 max	5.4 max	1.7 ±0.3	3.0 ±0.2	4.7 typ.	4.0 typ.	8.5 typ.	3.5 typ.
HCM1A0805V3-470 to 101-R	7.7 ±0.3	7.2 ±0.3	5.2 ±0.2	1.7 +0.15/-0.3	3.0 ±0.2	4.3 typ.	3.1 typ.	8.5 typ.	3.5 typ.

Part marking: Pin 1 indicator dot, 1AxxxV3 xxx= inductance value in μ H, R= decimal point, if no R is present then last digit is the number of zeros, wily R= Lot code

All soldering surfaces to be coplanar within 0.1 millimeters

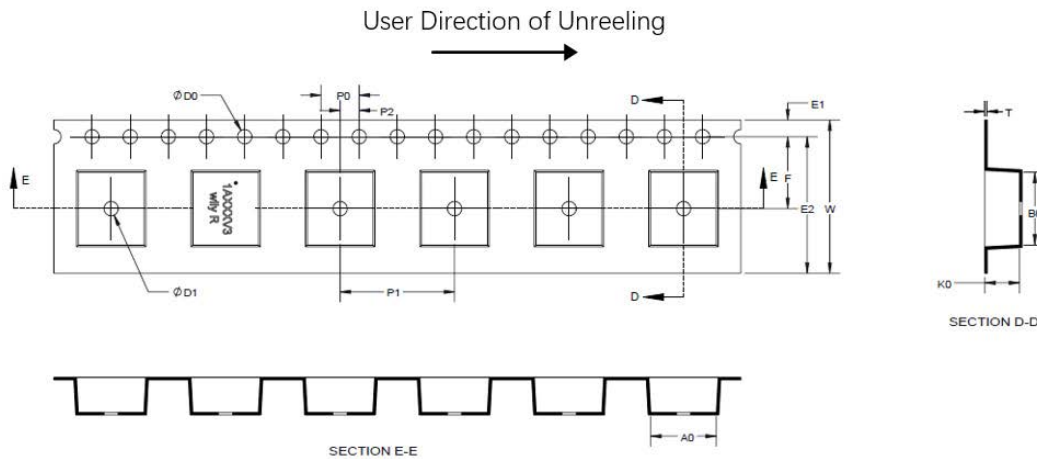
Traces or vias underneath the inductor is not recommended

Packaging information (mm)

Drawing not to scale

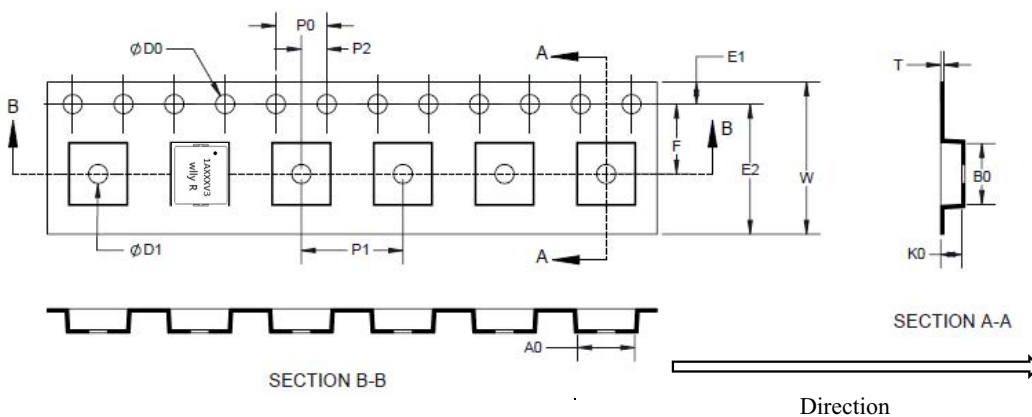
Supplied in tape and reel packaging, 500 parts per 13" diameter reel

HCM1A0805V3-R22 to 330-R



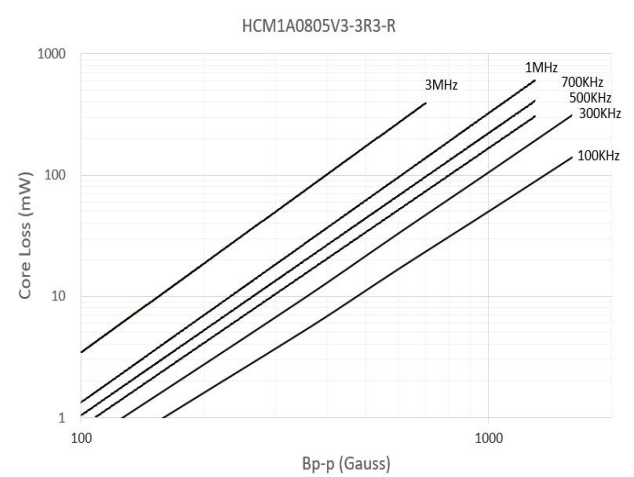
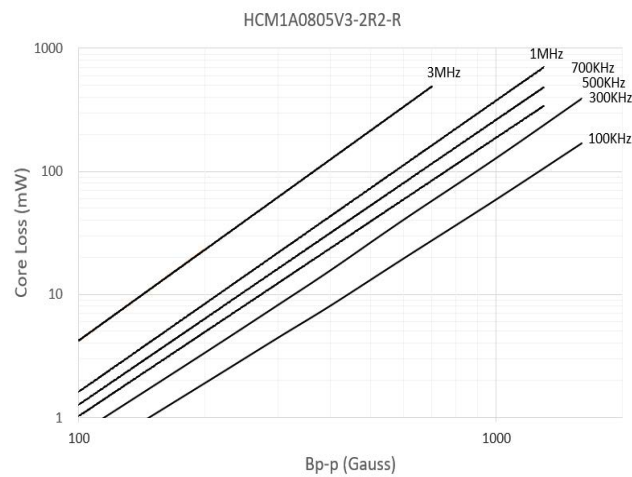
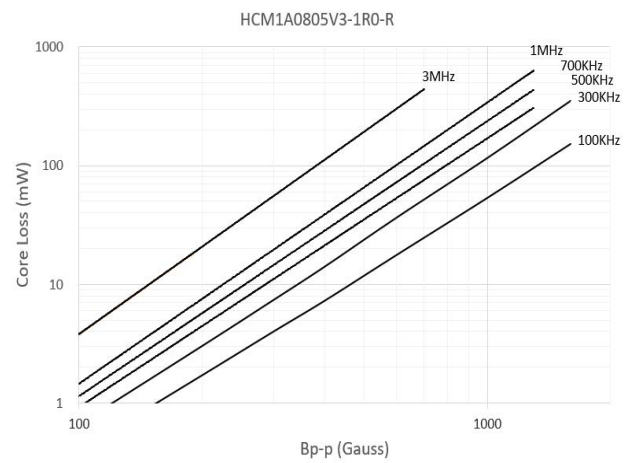
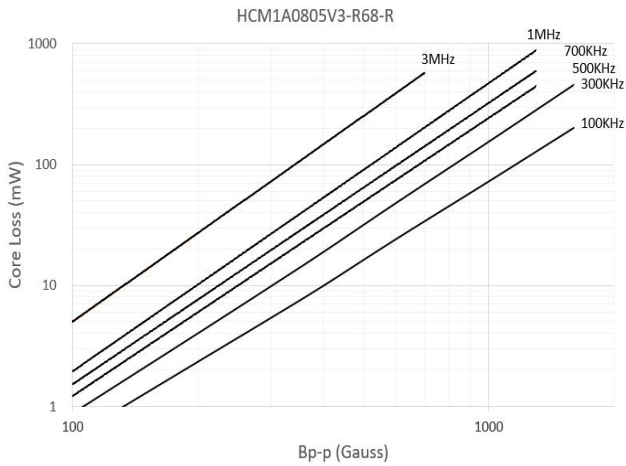
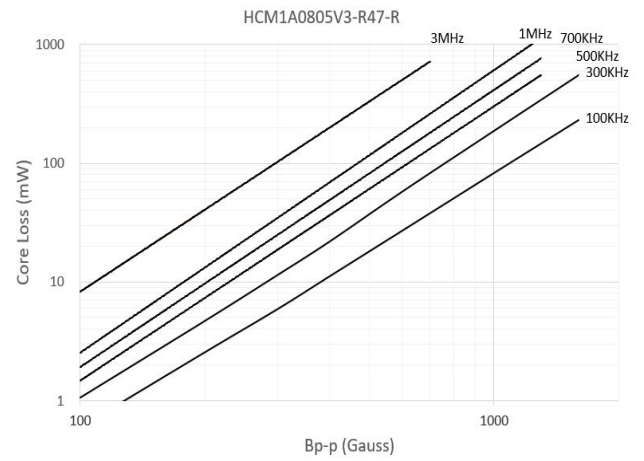
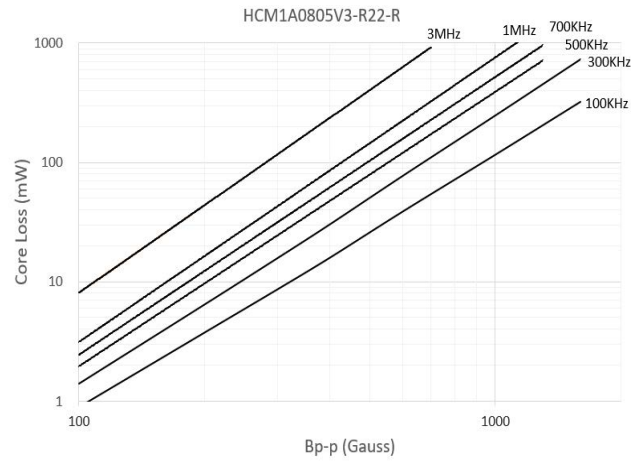
Dimension	Value
W ± 0.30	16.0
F ± 0.10	7.5
E1 ± 0.10	1.75
E2 Min	14.25
P0 ± 0.10	4.0
P1 ± 0.10	12.0
P2 ± 0.10	2.0
D0 $+0.10/-0$	1.5
D1 $+0.10/-0$	1.5
A0	8.5 ± 0.10
B0	8.7 ± 0.10
K0	6.0 ± 0.15
T	0.5 ± 0.05

HCM1A0805V3-470 to 101-R

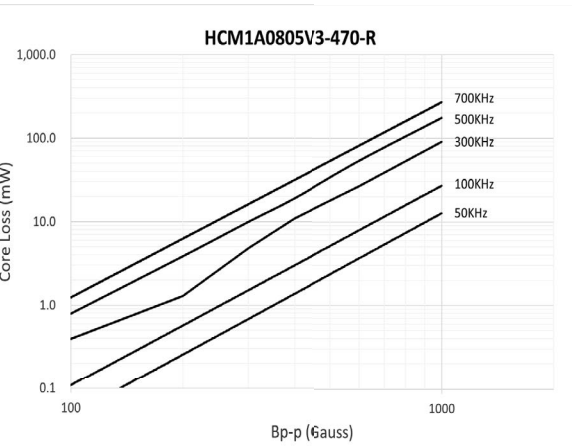
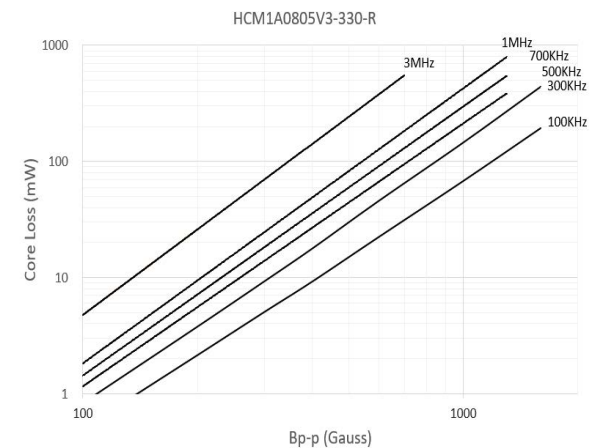
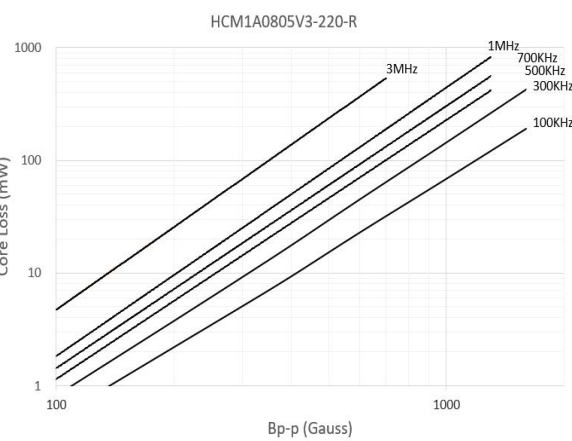
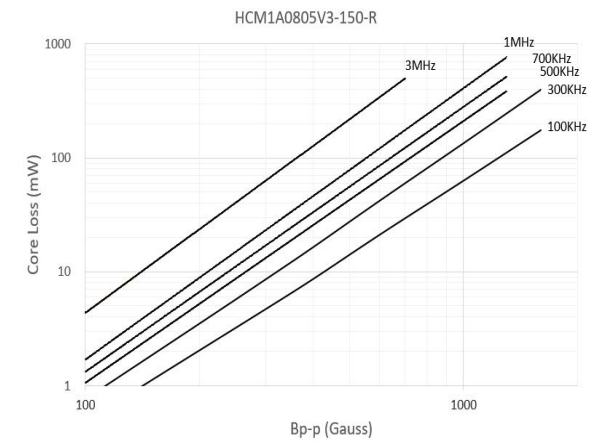
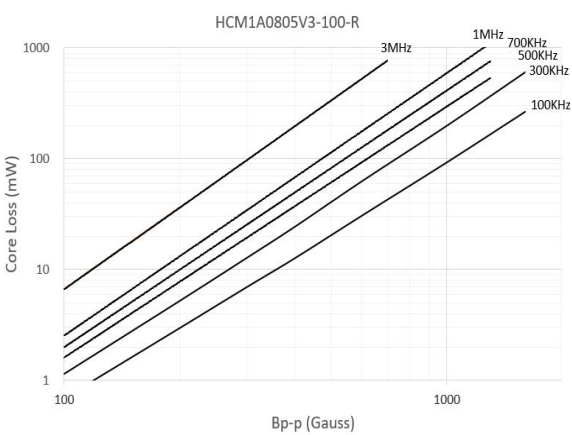
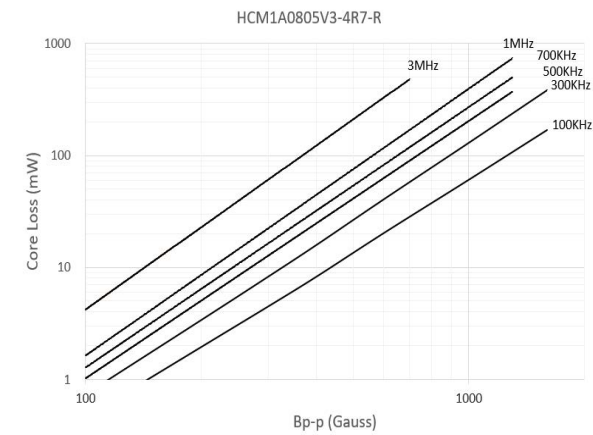


Dimension	Value
W ± 0.30	16.0
F ± 0.10	7.5
E1 ± 0.10	1.75
E2 Min	14.25
P0 ± 0.10	4.0
P1 ± 0.10	12.0
P2 ± 0.10	2.0
D0 ± 0.10	1.55
D1 ± 0.10	1.55
A0	7.7 ± 0.10
B0	8.2 ± 0.10
K0	5.7 ± 0.10
T	0.45 ± 0.05

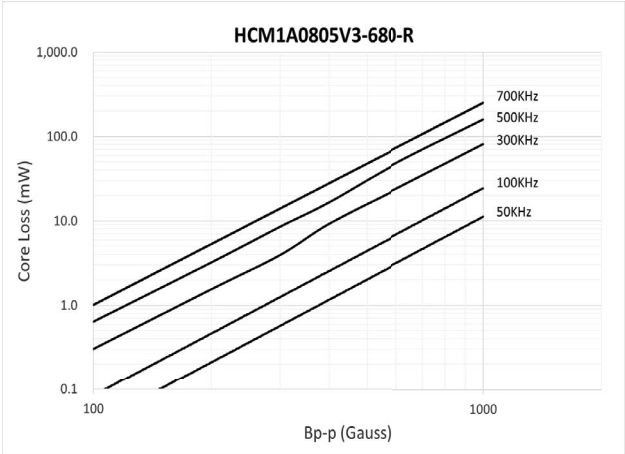
Core loss vs. Bp-p



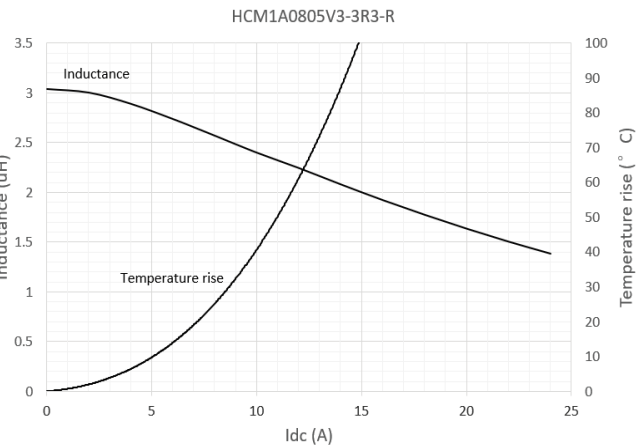
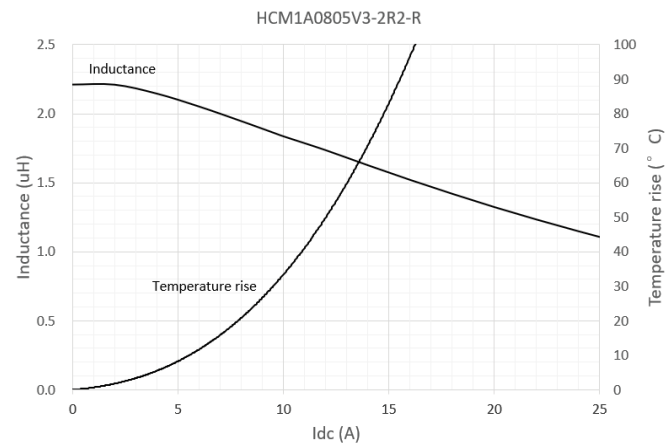
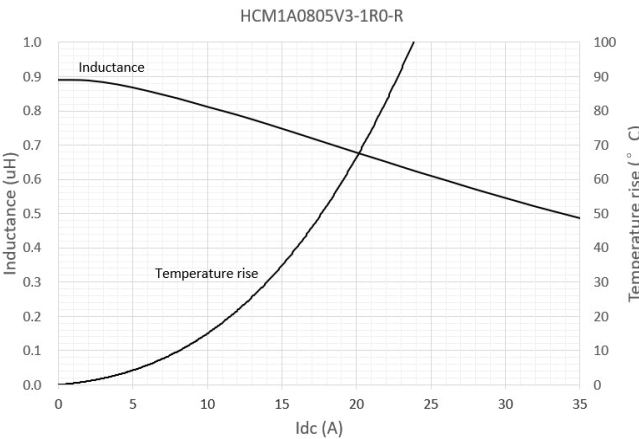
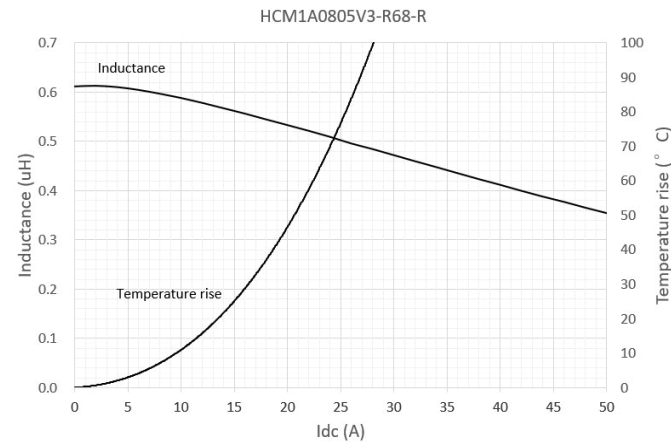
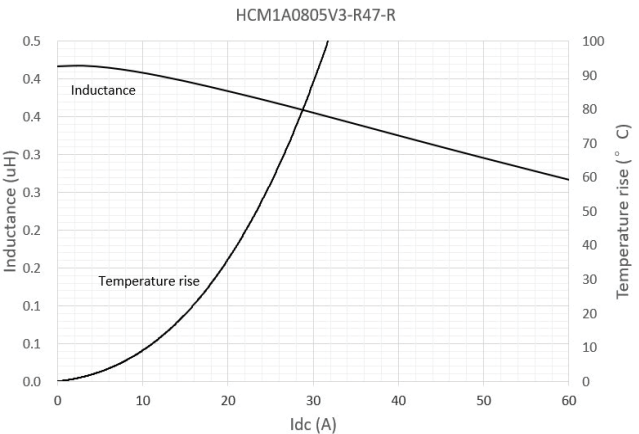
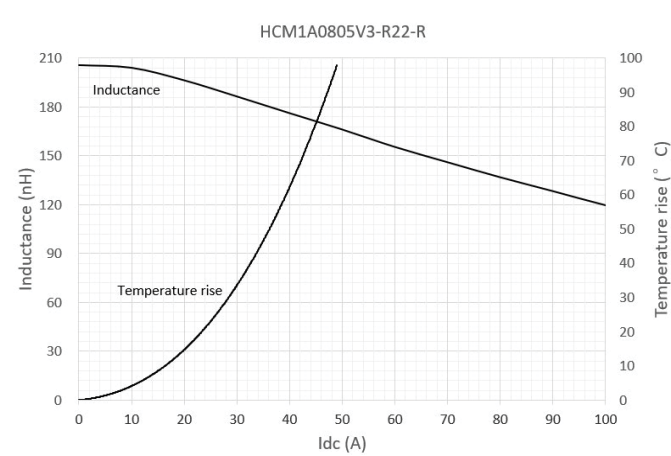
Core loss vs. Bp-p



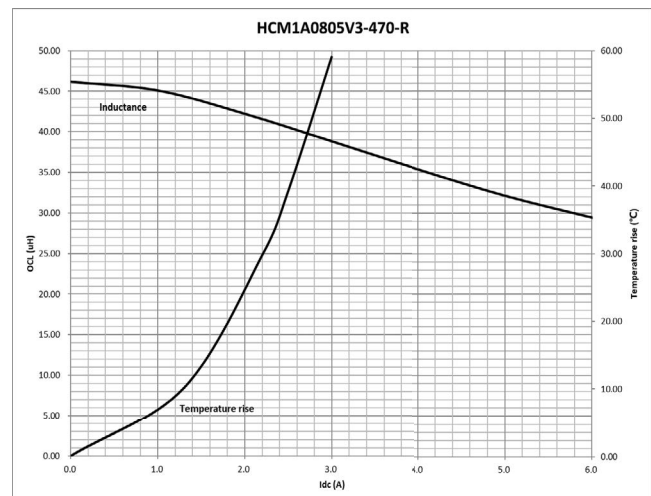
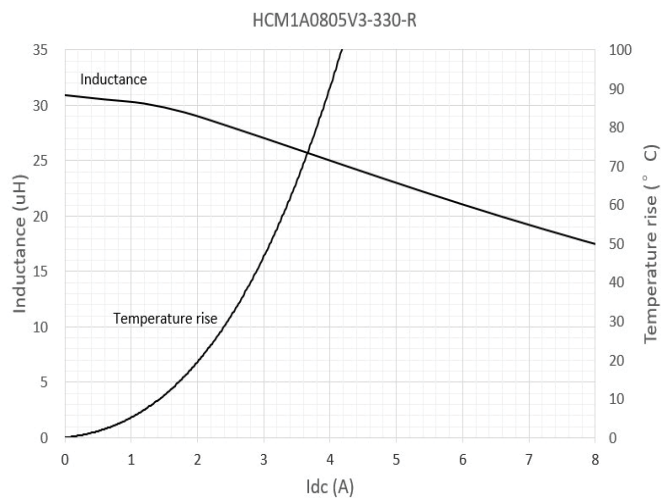
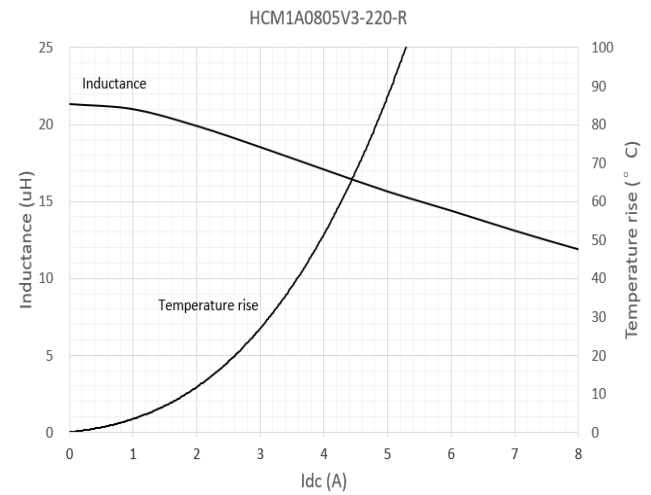
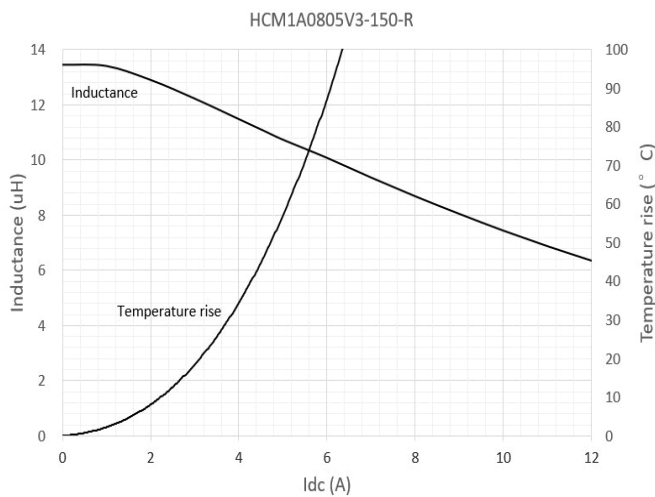
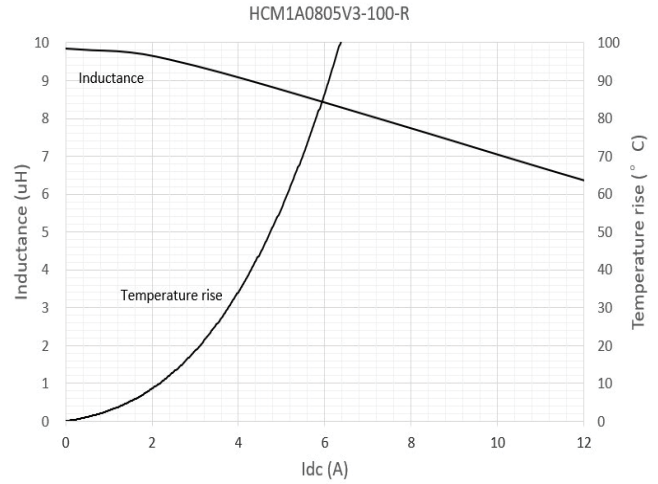
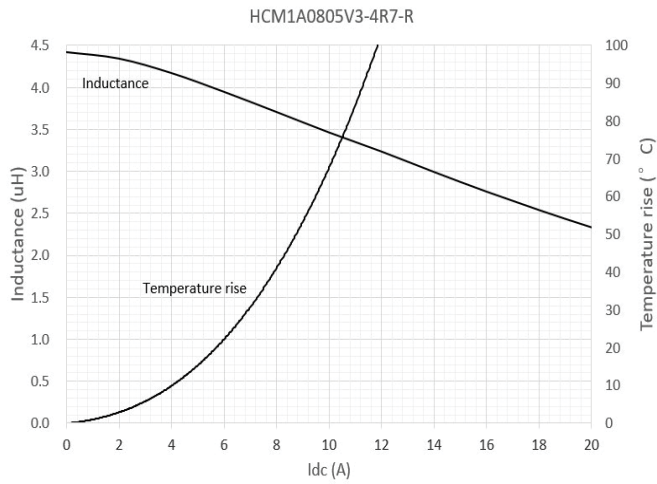
Core loss vs. Bp-p



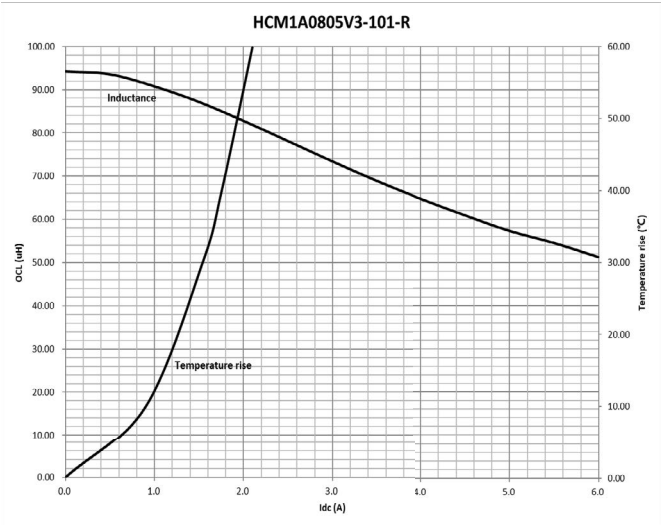
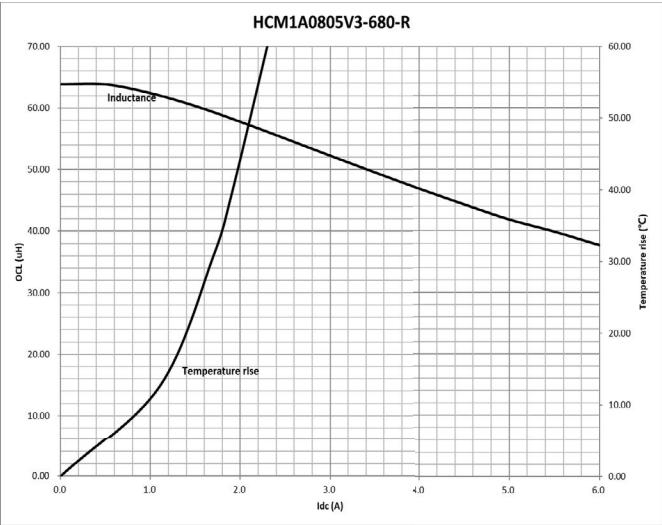
Inductance and temperature rise vs. Idc



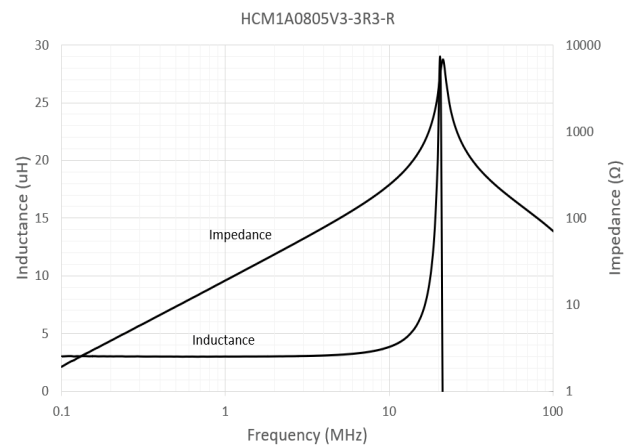
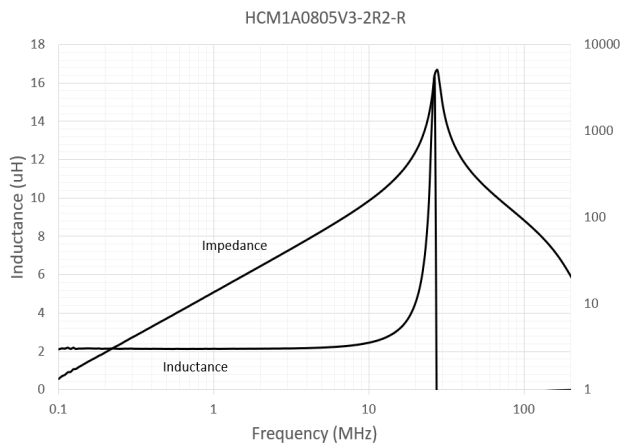
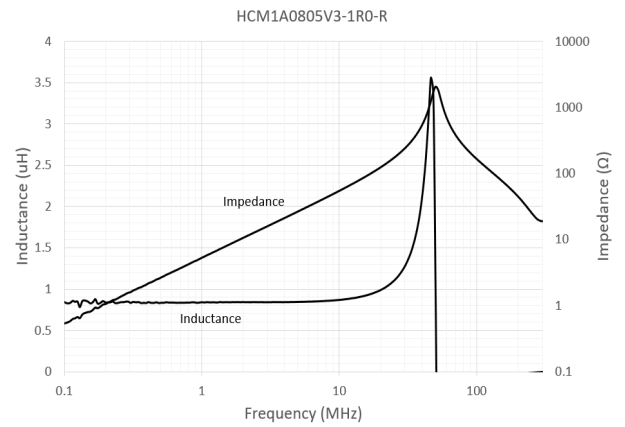
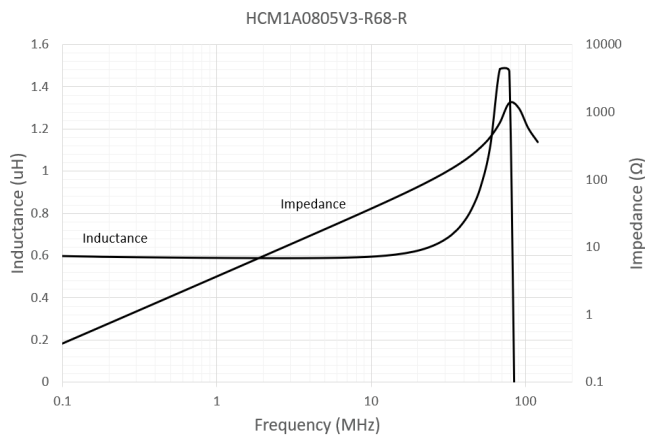
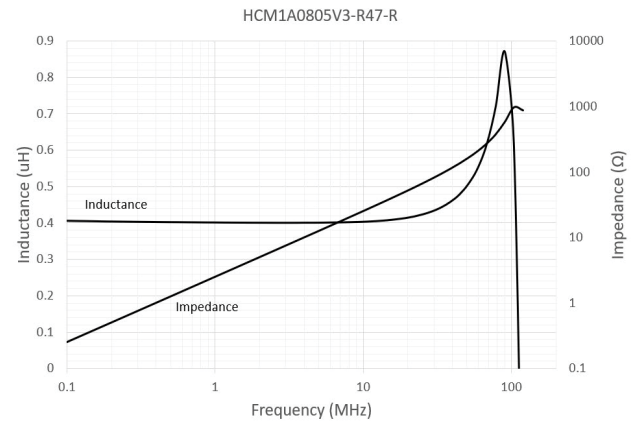
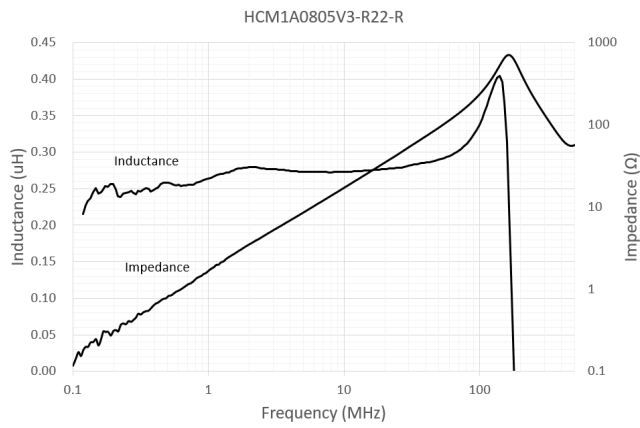
Inductance and temperature rise vs. I_{dc}



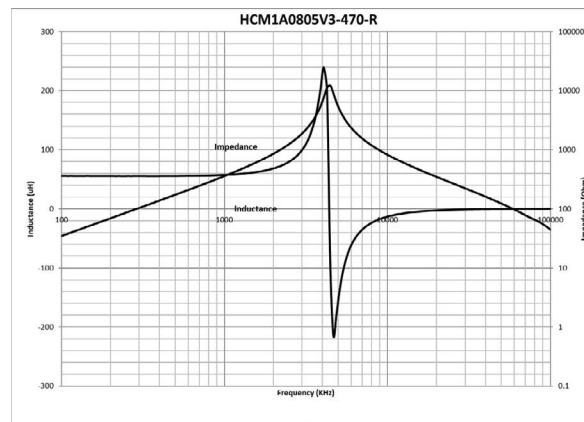
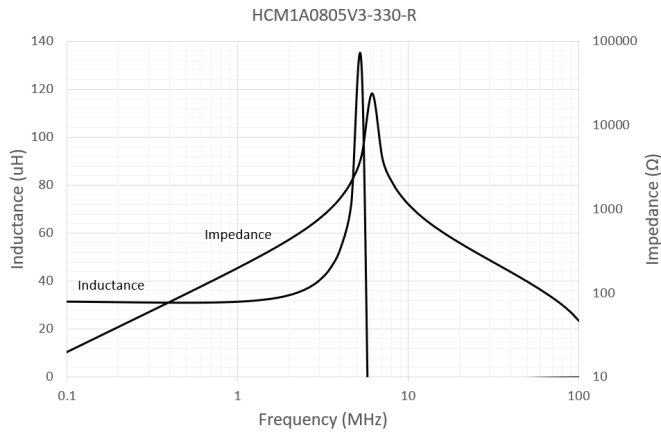
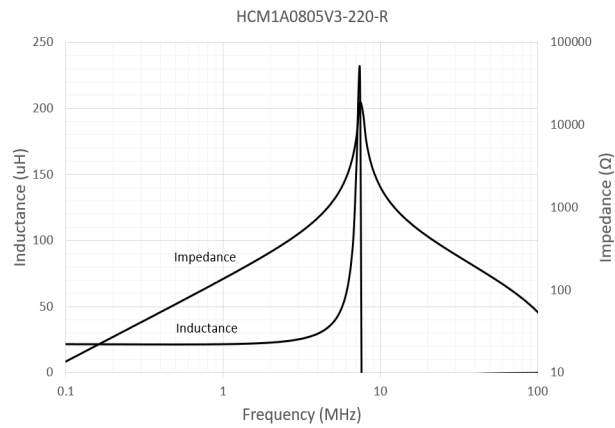
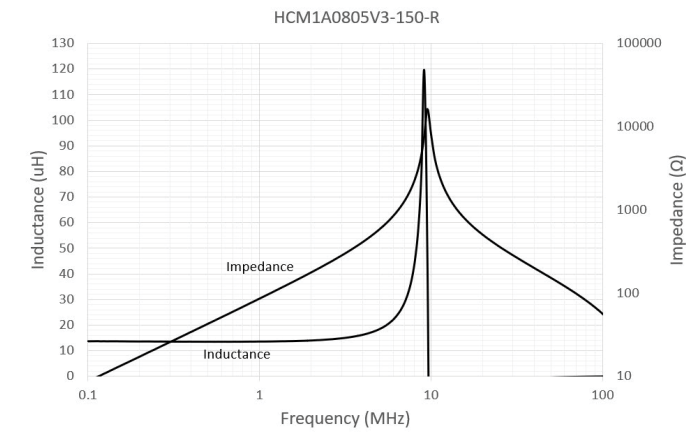
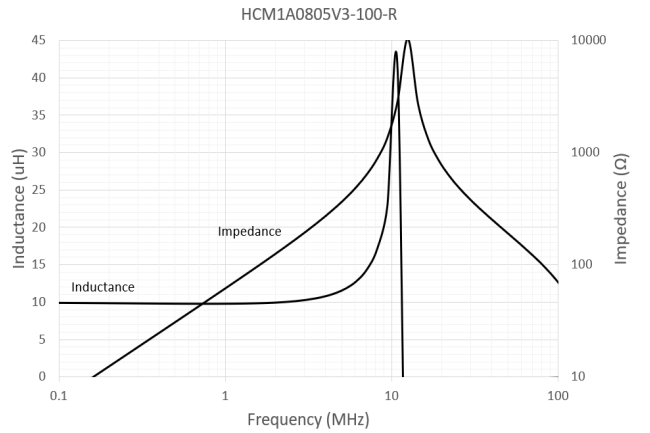
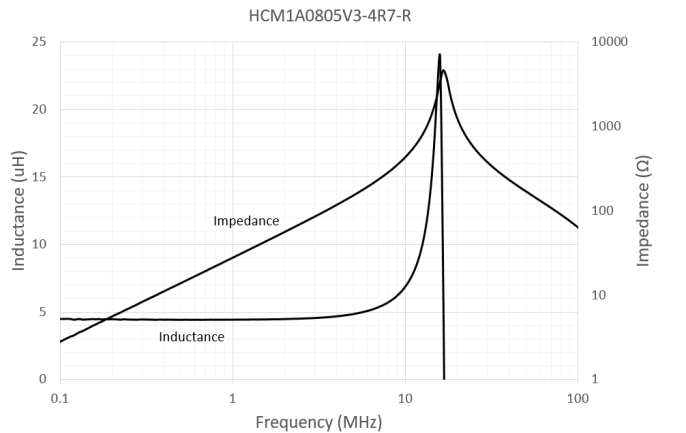
Inductance and temperature rise vs. Idc



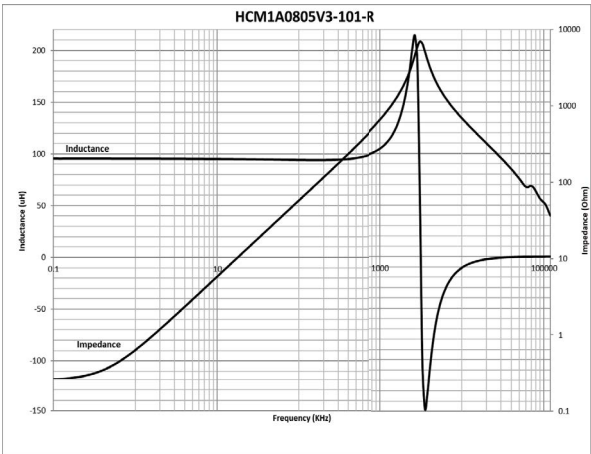
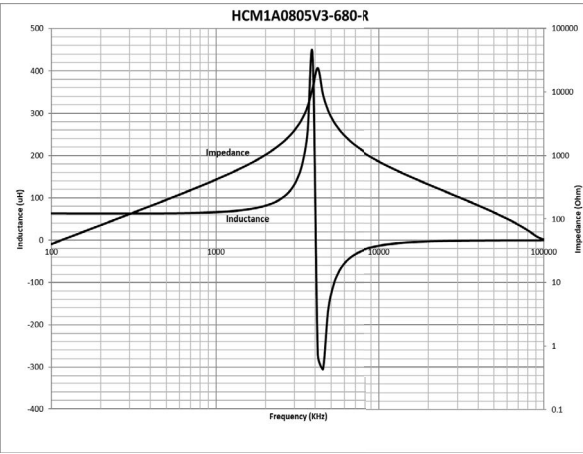
Inductance and impedance vs. frequency



Inductance and impedance vs. frequency



Inductance and impedance vs. frequency



Solder reflow profile

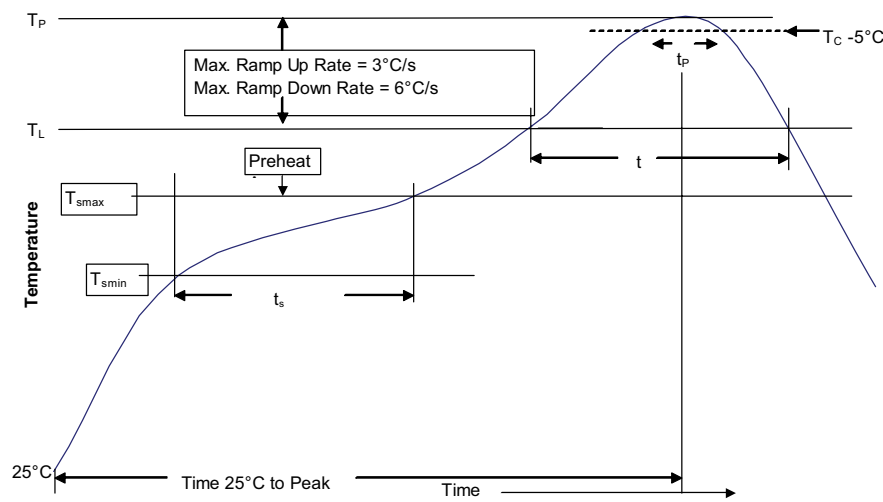


Table 1 - Standard SnPb solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T_{smin}) • Temperature max. (T_{smax}) • Time (T_{smin} to T_{smax}) (t_s)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
Ramp up rate T _L to T _P	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T _L) Time (t _L) maintained above T _L	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (T _P)*	Table 1	Table 2
Time (t _P)* within 5 °C of the specified classification temperature (T _C)	20 seconds*	30 seconds*
Ramp-down rate (T _P to T _L)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

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